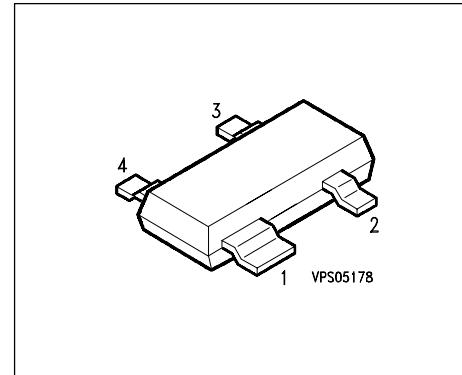


NPN Silicon RF Transistor

- For low noise, high-gain amplifiers up to 2GHz
- For linear broadband amplifiers
- $f_T = 8\text{GHz}$
- $F = 1.3\text{dB}$ at 900MHz

**ESD: Electrostatic discharge sensitive device, observe handling precaution!**

Type	Marking	Ordering Code	Pin Configuration				Package
BFP 193	RCs	Q62702-F1282	1 = C	2 = E	3 = B	4 = E	SOT-143

Maximum Ratings

Parameter	Symbol	Values	Unit
Collector-emitter voltage	V_{CEO}	12	V
Collector-emitter voltage	V_{CES}	20	
Collector-base voltage	V_{CBO}	20	
Emitter-base voltage	V_{EBO}	2	
Collector current	I_C	80	mA
Base current	I_B	10	
Total power dissipation $T_S \leq 72^\circ\text{C}$	P_{tot}	580	mW
Junction temperature	T_j	150	°C
Ambient temperature	T_A	- 65 ... + 150	
Storage temperature	T_{stg}	- 65 ... + 150	

Thermal Resistance

Junction - soldering point ¹⁾	R_{thJS}	≤ 135	K/W
--	------------	------------	-----

1) T_S is measured on the collector lead at the soldering point to the pcb.

Electrical Characteristics at $T_A = 25^\circ\text{C}$, unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics					
Collector-emitter breakdown voltage $I_C = 1 \text{ mA}, I_B = 0$	$V_{(\text{BR})\text{CEO}}$	12	-	-	V
Collector-emitter cutoff current $V_{\text{CE}} = 20 \text{ V}, V_{\text{BE}} = 0$	I_{CES}	-	-	100	μA
Collector-base cutoff current $V_{\text{CB}} = 10 \text{ V}, I_E = 0$	I_{CBO}	-	-	100	nA
Emitter-base cutoff current $V_{\text{EB}} = 1 \text{ V}, I_C = 0$	I_{EBO}	-	-	1	μA
DC current gain $I_C = 30 \text{ mA}, V_{\text{CE}} = 8 \text{ V}$	h_{FE}	50	100	200	-

Electrical Characteristics at $T_A = 25^\circ\text{C}$, unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
AC Characteristics					
Transition frequency $I_C = 50 \text{ mA}, V_{CE} = 8 \text{ V}, f = 500 \text{ MHz}$	f_T	6	8	-	GHz
Collector-base capacitance $V_{CB} = 10 \text{ V}, f = 1 \text{ MHz}$	C_{cb}	-	0.6	0.9	pF
Collector-emitter capacitance $V_{CE} = 10 \text{ V}, f = 1 \text{ MHz}$	C_{ce}	-	0.25	-	
Emitter-base capacitance $V_{EB} = 0.5 \text{ V}, f = 1 \text{ MHz}$	C_{eb}	-	1.8	-	
Noise figure $I_C = 10 \text{ mA}, V_{CE} = 8 \text{ V}, Z_S = Z_{Sopt}$ $f = 900 \text{ MHz}$ $f = 1.8 \text{ GHz}$	F	-	1.3	-	dB
-	-	-	2.1	-	
Power gain 2) $I_C = 30 \text{ mA}, V_{CE} = 8 \text{ V}, Z_S = Z_{Sopt}$ $Z_L = Z_{Lopt}$ $f = 900 \text{ MHz}$ $f = 1.8 \text{ GHz}$	G_{ma}	-	17.5	-	
-	-	-	11.5	-	
Transducer gain $I_C = 30 \text{ mA}, V_{CE} = 8 \text{ V}, Z_S = Z_L = 50 \Omega$ $f = 900 \text{ MHz}$ $f = 1.8 \text{ GHz}$	$ S_{21e} ^2$	-	14.5	-	
-	-	-	8.5	-	

2) $G_{ma} = |S_{21}/S_{12}| (k - (k^2 - 1)^{1/2})$

SPICE Parameters (Gummel-Poon Model, Berkeley-SPICE 2G.6 Syntax) :
Transistor Chip Data

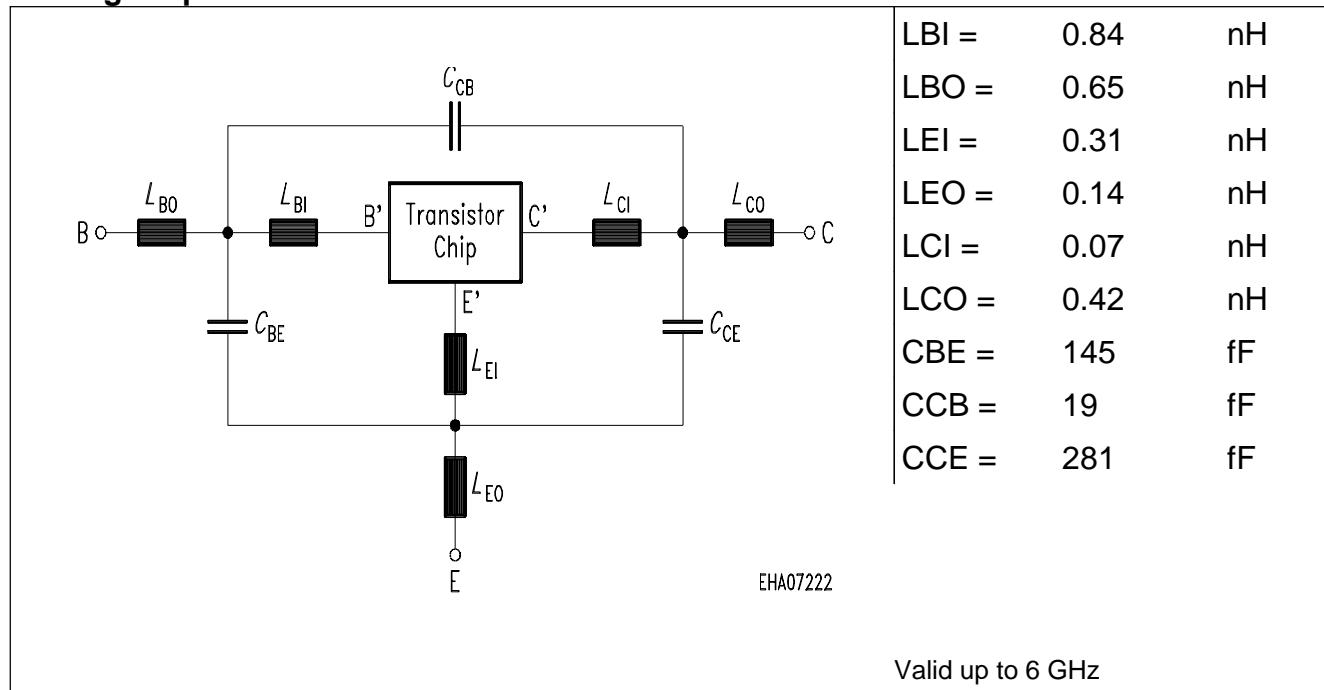
IS =	0.2738	fA	BF =	125	-	NF =	0.95341	-
VAF =	24	V	IKF =	0.26949	A	ISE =	10.627	fA
NE =	1.935	-	BR =	14.267	-	NR =	1.4289	-
VAR =	3.8742	V	IKR =	0.037925	A	ISC =	0.037409	fA
NC =	0.94371	-	RB =	1	Ω	IRB =	0.91763	mA
RBM =	1.8368	Ω	RE =	0.76534	Ω	RC =	0.11938	Ω
CJE =	1.1824	fF	VJE =	0.70276	V	MJE =	0.48654	-
TF =	18.828	ps	XTF =	0.69477	-	VTF =	0.8	V
ITF =	0.96893	mA	PTF =	0	deg	CJC =	935.03	fF
VJC =	1.1828	V	MJC =	0.30002	-	XCJC =	0.053563	-
TR =	1.0037	ns	CJS =	0	fF	VJS =	0.75	V
MJS =	0	-	XTB =	0	-	EG =	1.11	eV
XTI =	3	-	FC =	0.72063	-	TNOM	300	K

All parameters are ready to use, no scaling is necessary.

Extracted on behalf of SIEMENS Small Signal Semiconductors by:

Institut für Mobil- und Satellitenfunktechnik (IMST)

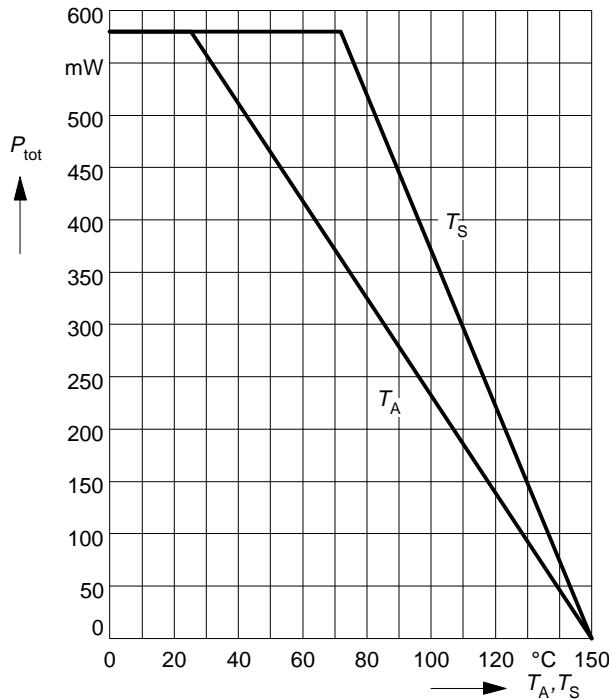
© 1996 SIEMENS AG

Package Equivalent Circuit:


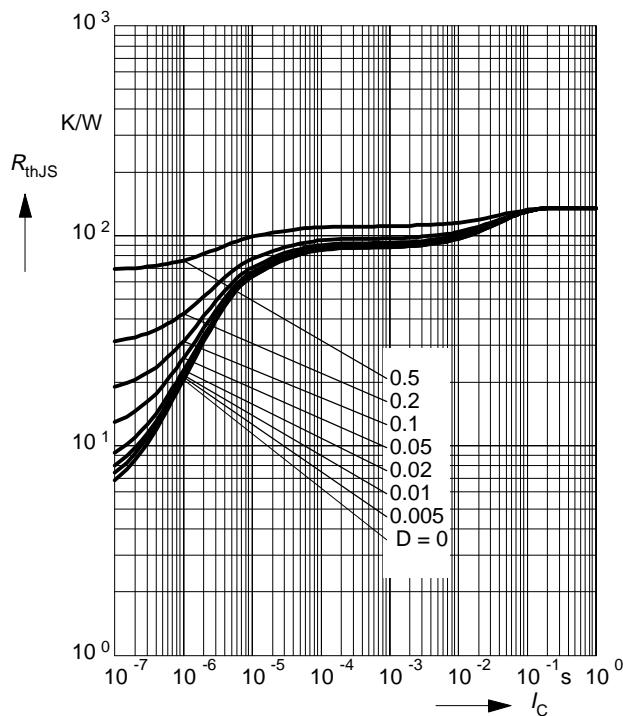
For examples and ready to use parameters please contact your local Siemens distributor or sales office to obtain a Siemens CD-ROM or see Internet: <http://www.siemens.de/Semiconductor/products/35/35.htm>

Total power dissipation $P_{\text{tot}} = f(T_A^*, T_S)$

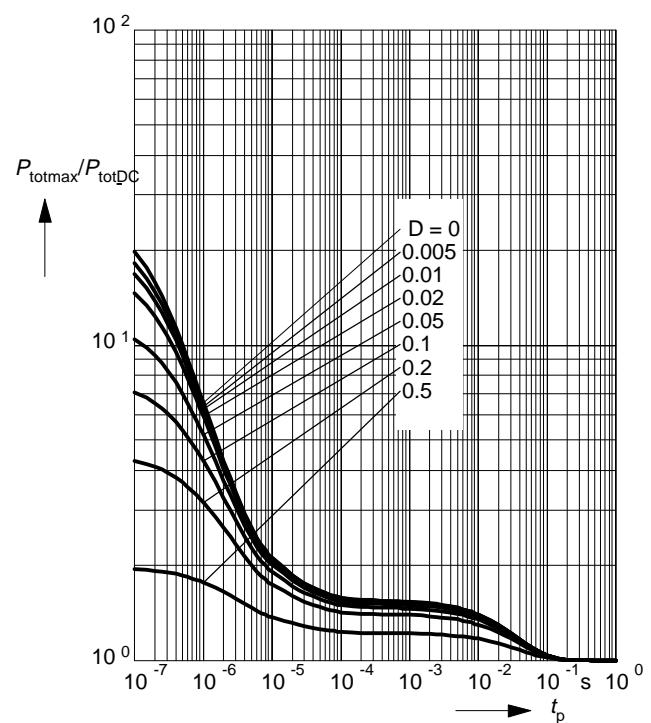
* Package mounted on epoxy



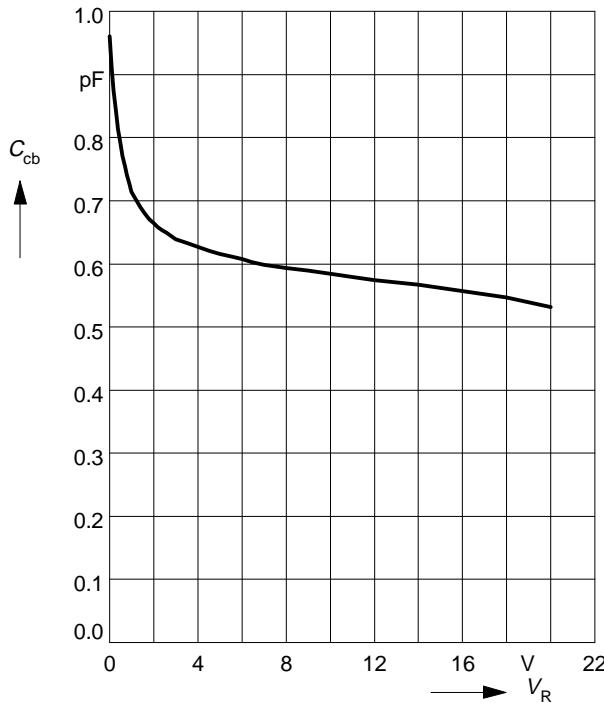
Permissible Pulse Load $R_{\text{thJS}} = f(t_p)$



Permissible Pulse Load $P_{\text{totmax}}/P_{\text{totDC}} = f(t_p)$



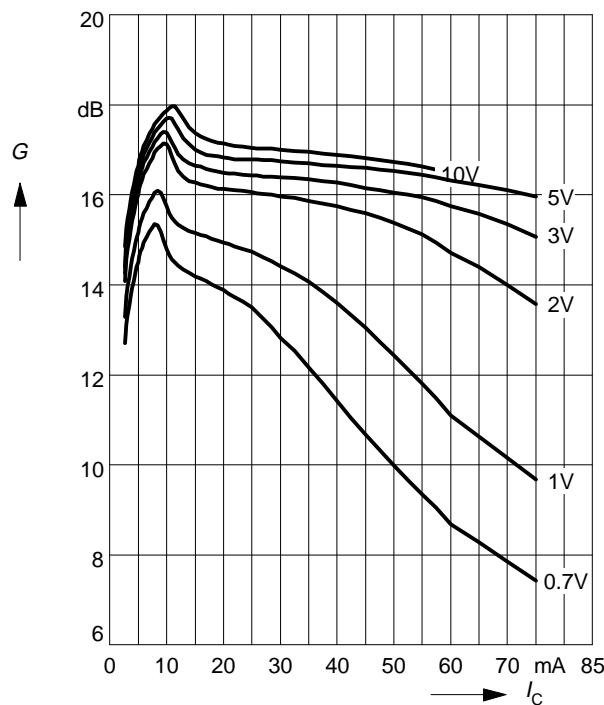
Collector-base capacitance $C_{cb} = f(V_{CB})$
 $V_{BE} = v_{be} = 0$, $f = 1\text{MHz}$



Power Gain $G_{ma}, G_{ms} = f(I_C)$

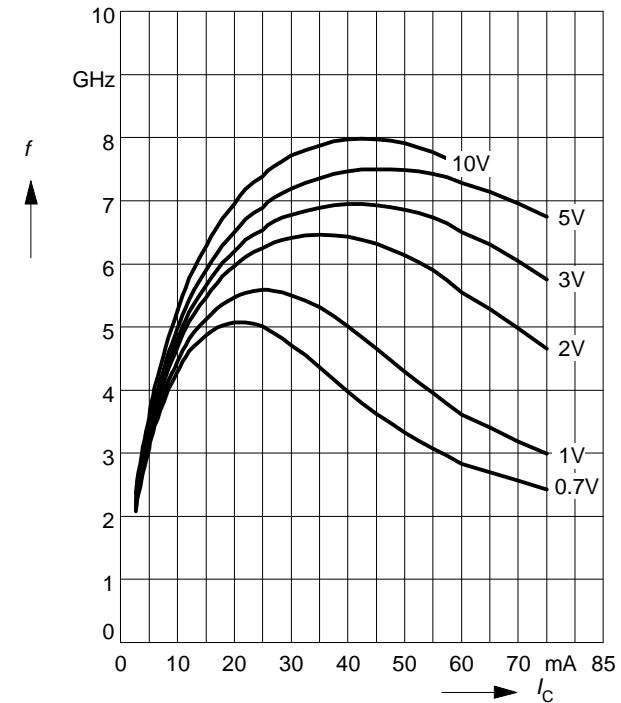
$f = 0.9\text{GHz}$

V_{CE} = Parameter



Transition frequency $f_T = f(I_C)$

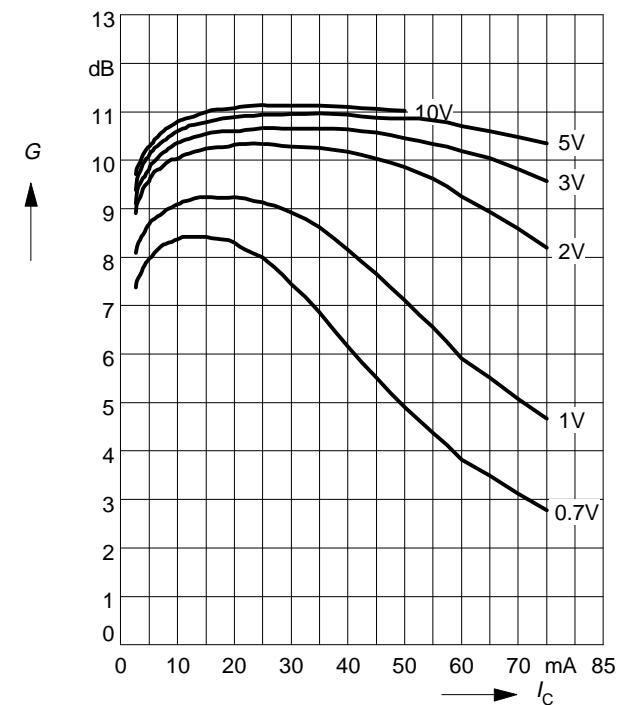
V_{CE} = Parameter



Power Gain $G_{ma}, G_{ms} = f(I_C)$

$f = 1.8\text{GHz}$

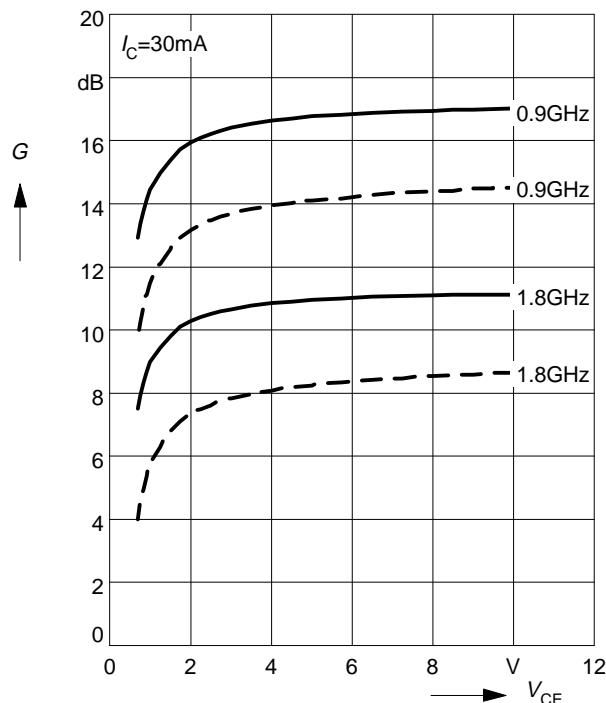
V_{CE} = Parameter



Power Gain G_{ma} , $G_{ms} = f(V_{CE})$: _____

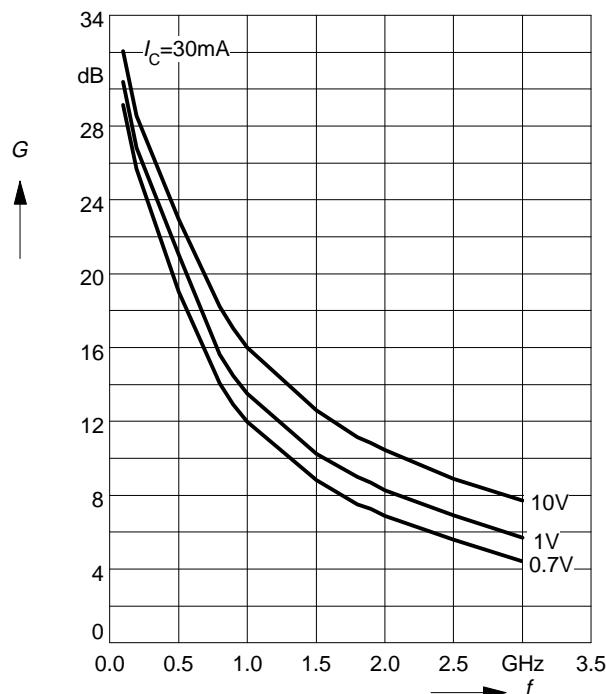
$|S_{21}|^2 = f(V_{CE})$: -----

f = Parameter



Power Gain G_{ma} , $G_{ms} = f(f)$

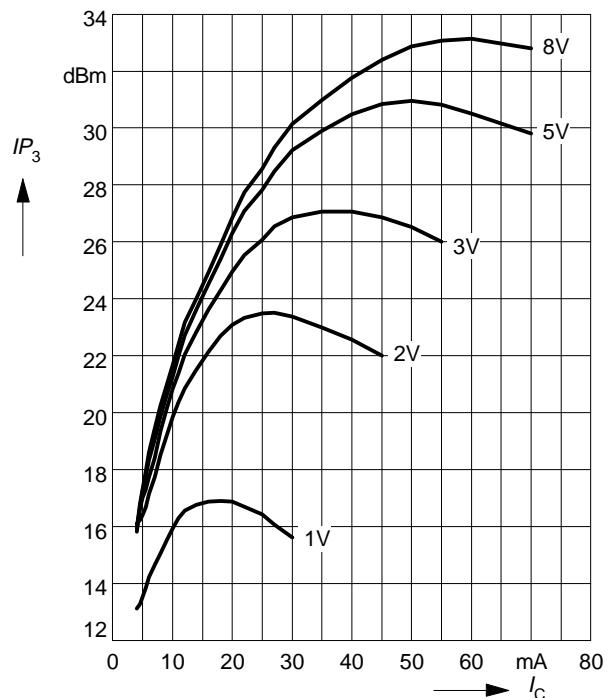
V_{CE} = Parameter



Intermodulation Intercept Point $IP_3 = f(I_C)$

(3rd order, Output, $Z_S=Z_L=50\Omega$)

V_{CE} = Parameter, $f = 900\text{MHz}$



Power Gain $|S_{21}|^2 = f(f)$

V_{CE} = Parameter

